

友順科技股份有限公司

UNISONIC TECHNOLOGIES CO., LTD

產 品 變 更 通 PRODUCT CHANGE NOTIFICATION

知

PCN No.	PCN-211204	Issue Date	21 th -Dec-2021
TITLE	TO-92封裝 新增導電膠製程 (TO-92 L/F Add Silver Pa	ste Process)	Page1 of 2

變更主旨(TITLE):

TO-92封裝 新增導電膠製程,以利提升產能。

TO-92 L/F Add Silver Paste Process, increase production capacity.

變更類別(CATEGORY):

□Design	□Process	Raw Material	
□Testing	□Packing/Sh	ipping/Labeling	□Other

<u>變更說明(DESCRIPTION OF CHANGE):</u>

TO-92封裝 新增導電膠製程,以利提升產能。

TO-92 L/F Add Silver Paste Process, increase production capacity.

製程比對(Process Comparison)

	original	After	
Process	Solder Process	Solder / Silver Paste Process	Coexist

品質驗證(QUALIFICATION AND RELIABILITY DATA):

本項變更不影響原有品質可靠性。

No change to quality and reliability in the final product.

生效日期(EFFECTIVE DATE OF CHNAGE):

21th-Mar-2022



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適用範圍(APPLICABLE PRODUCTS):

MCR101-X(Z1)、MCR101-X、MCR100-X、PCR406-X、UZ0107-X、UZ0103-6/8、UT131-5/6/8、BT169B/D/E/G 系列

MCR101-X(Z1) \ MCR101-X \ MCR100-X \ PCR406-X \ UZ0107-X \ UZ0103-6/8 \ UT131-5/6/8 \ BT169B/D/E/G Series.

客戶回簽(CUSTOMER RESPONSE):

請使用以下的確認通知回覆或以電子郵件同意認可或告知需要補充的資訊。如UTC於30日以內未收到確認通知, 我們將視同 貴司同意此變更。

Please use the acknowledgement below or E-Mail to grant approval or request additional information. If UTC does not receive acknowledgement within 30days of this notice it will be assumed that this change is acceptable.

□Approved	Rejected	Other	
Customer Sign	nature:		

友順對此變更所引起之不便表達致歉,如果對本變更有任何問題,請與我們的業務代表或經銷商聯絡。 We apologize for any inconvenience causing from this change, if you have any questions concerning this change, please contact your local sales or UTC's sales representative.